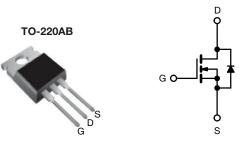
Vishay Siliconix

E Series Power MOSFET



N Channal	MOSEET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.6				
Q _g max. (nC)	40				
Q _{gs} (nC)	5				
Q _{gd} (nC)	9				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	SiHP7N60E-E3			
Lead (Pb)-free and halogen-free	SiHP7N60E-BE3			
Lead (FD)-life and halogen-life	SiHP7N60E-GE3			

ABSOLUTE MAXIMUM RATINGS (T	_C = 25 °C, unle	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V	600	
Drain-source voltage	T _C = - 25 °C,	$I_D = 250 \mu A$	V_{DS}	575	V
Gate-source voltage			V_{GS}	± 30	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C		7	
	VGS at 10 V	T _C = 100 °C	ID	5	Α
Pulsed drain current ^a			I _{DM}	18	
Linear derating factor				0.63	W/°C
Single pulse avalanche energy b			E _{AS}	43	mJ
Maximum power dissipation			P_{D}	78	W
Operating junction and storage temperature range	Э		T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	age slope T _J = 125 °C		al\	70	V/ns
Reverse diode dV/dt ^d			dV/dt	3	V/IIS
Soldering recommendations (peak temperature) c	For ²	10 s		300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 13.8 mH, R_q = 25 Ω , I_{AS} = 2.5 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, dI/dt = 100 A/µs, starting $T_J = 25$ °C



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W	
Maximum junction-to-case (drain)	R_{thJC}	-	1.6	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	609	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.68	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	-	4	V
Coto por man lankaga		V _{GS} = ± 20 V		-	-	± 100	nΑ
Gate-source leakage	I_{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zero gate voltage drain current	l	V _{DS} =	= 600 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 480 \text{ V}$	V, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 3.5 A	-	0.5	0.6	Ω
Forward transconductance	9 _{fs}	V _{DS} :	= 50 V, I _D = 3.5 A	-	1.9	-	S
Dynamic		•		•	•	•	
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	680	-	
Output capacitance	C _{oss}	· ·	$V_{DS} = 100 V$	-	39	-]
Reverse transfer capacitance	C_{rss}	f = 1 MHz		-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	34	-	pF
Effective output capacitance, time related ^b	$C_{o(tr)}$			-	100	-	
Total gate charge	Qg			-	20	40	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 3.5 \text{ A}, V_{DS} = 480 \text{ V}$		5	-	nC
Gate-drain charge	Q _{gd}			-	9	-	
Turn-on delay time	t _{d(on)}			-	13	26	
Rise time	t _r	V _{DD} = 480 V, I _D = 3.5 A,		-	13	26	200
Turn-off delay time	t _{d(off)}	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		-	24	48	ns
Fall time	t _f			-	14	28	
Gate input resistance	R _g	f = 1 MHz, open drain		-	1.1	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7	_
Pulsed diode forward current	I _{SM}			-	-	18	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 3.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}			-	230	-	ns
Reverse recovery charge	Q _{rr}		$5 ^{\circ}\text{C}, I_{\text{F}} = I_{\text{S}} = 3.5 \text{A},$	-	1.9	-	μC
Reverse recovery current	I _{RRM}	ui/dt =	100 A/ μ s, V _R = 20 V	-	14	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

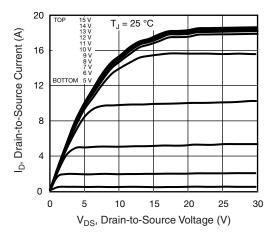


Fig. 1 - Typical Output Characteristics

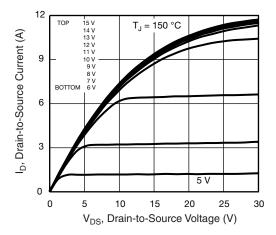


Fig. 2 - Typical Output Characteristics

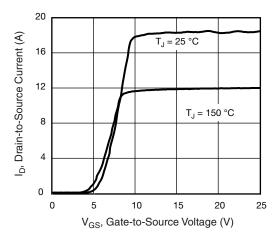


Fig. 3 - Typical Transfer Characteristics

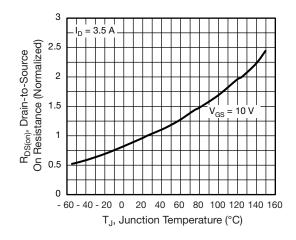


Fig. 4 - Normalized On-Resistance vs. Temperature

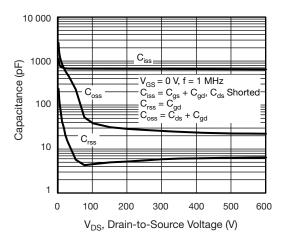


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

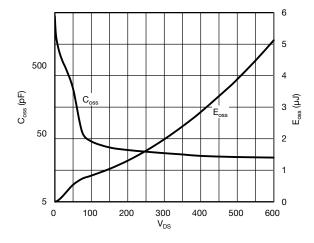


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



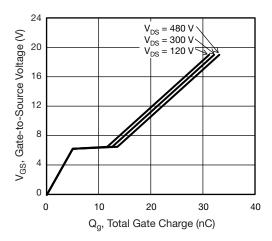


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

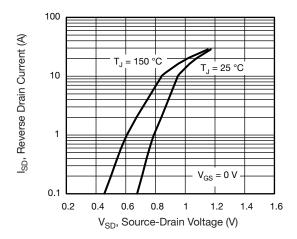


Fig. 8 - Typical Source-Drain Diode Forward Voltage

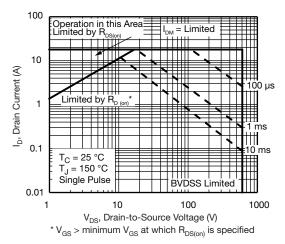


Fig. 9 - Maximum Safe Operating Area

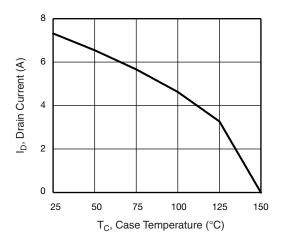


Fig. 10 - Maximum Drain Current vs. Case Temperature

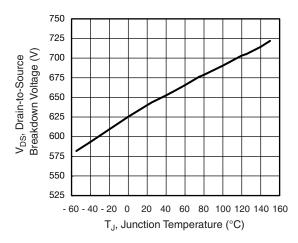


Fig. 11 - Temperature vs. Drain-to-Source Voltage



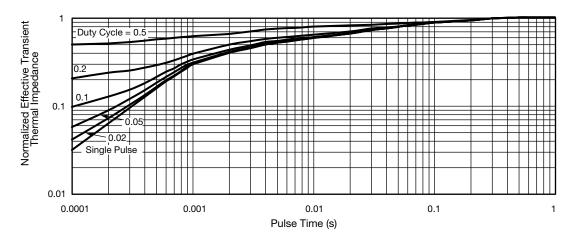


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

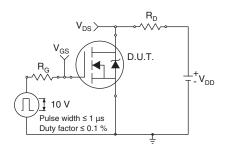


Fig. 13 - Switching Time Test Circuit

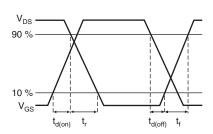


Fig. 14 - Switching Time Waveforms

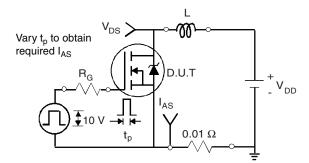


Fig. 15 - Unclamped Inductive Test Circuit

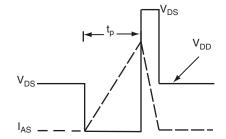


Fig. 16 - Unclamped Inductive Waveforms

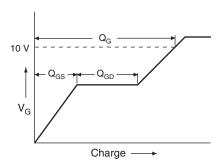


Fig. 17 - Basic Gate Charge Waveform

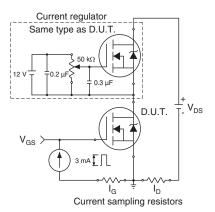
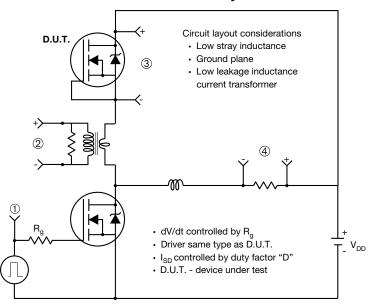


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



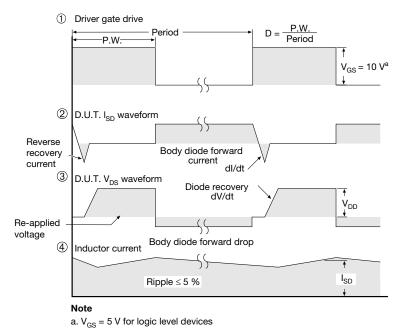
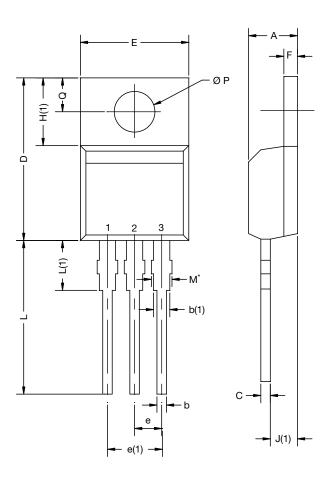


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØΡ	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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